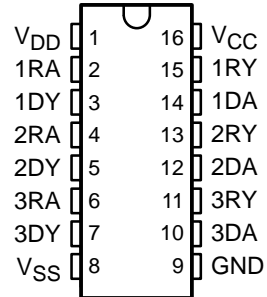


TL145406 TRIPLE RS-232 DRIVERS/RECEIVERS

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- Meets or Exceeds the Requirements of ANSI TIA/EIA-232-F and ITU V.28
- Designed to Support Data Rates up to 120 kbit/s Over 3-m Cable
- ESD Protection Exceeds 5 kV on All Pins
- Flow-Through Design
- Wide-Driver Supply Voltage . . . ± 7.5 V to ± 15 V
- Functionally Interchangeable With Motorola MC145406 and Texas Instruments SN75C1406

DW OR N PACKAGE
(TOP VIEW)



description

The TL145406 is a bipolar device containing three independent drivers and receivers that are used to interface data terminal equipment (DTE) with data circuit-terminating equipment (DCE). The drivers and receivers of the TL145406 are similar to those of the SN75188 quadruple driver and SN75189A quadruple receiver, respectively. The pinout matches the flow-through design of the SN75C1406 to reduce the board space required and to allow easy interconnection. The bipolar circuits and processing of the TL145406 provide a rugged low-cost solution for this function at the expense of quiescent power and external passive components relative to the SN75C1406.

The TL145406 complies with the requirements of TIA/EIA-232-F and ITU (formerly CCITT) V.28 standards. These standards are for data interchange between a host computer and peripheral at signaling rates up to 20 kbit/s. The switching speeds of the TL145406 are fast enough to support rates up to 120 kbit/s with lower capacitive loads (shorter cables). Interoperability at the higher signaling rates cannot be assured unless the designer has design control of the cable and of the interface circuits at both ends. For interoperability at signaling rates to 120 kbit/s, use of TIA/EIA-423-B (ITU V.10) and TIA/EIA-422-B (ITU V.11) standards is recommended.

The TL145406 is characterized for operation from 0°C to 70°C.

AVAILABLE OPTIONS

T _A	PACKAGED DEVICES	
	PLASTIC DIP (N)	PLASTIC SMALL OUTLINE (DW)
0°C to 70°C	TL145406N	TL145406DW

The DW package also is available taped and reeled. Add the suffix R to the device type (e.g., TL145406DWR).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

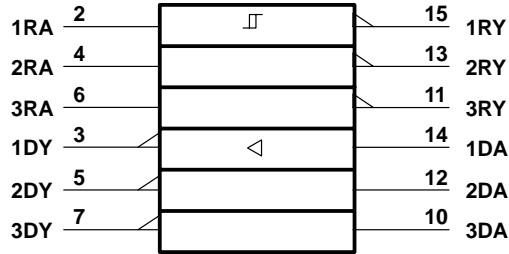
**TEXAS
INSTRUMENTS**

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TL145406 TRIPLE RS-232 DRIVERS/RECEIVERS

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logic symbol†



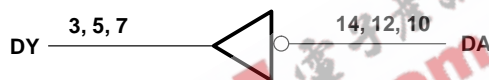
† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)

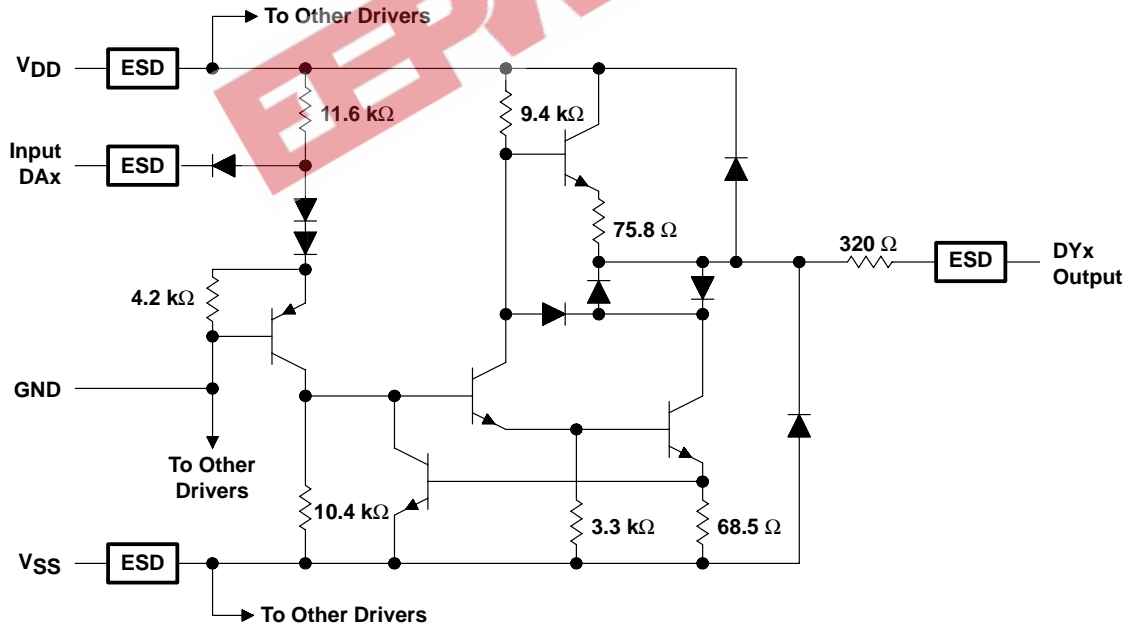
Typical of Each Receiver



Typical of Each Driver

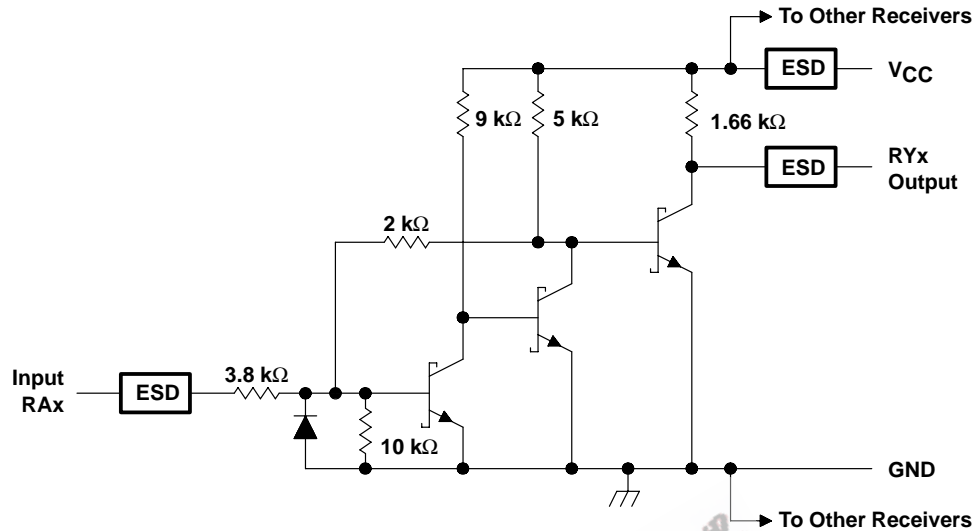


schematic (each driver)



Resistor values shown are nominal.

schematic (each receiver)



Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage (see Note 1): V_{CC}	10 V
V_{DD}	15 V
V_{SS}	-15 V
Input voltage range: Driver	-15 V to 7 V
Receiver	-30 V to 30 V
Driver output voltage range	-15 V to 15 V
Receiver low-level output current	20 mA
Package thermal impedance, θ_{JA} (see Note 2): DW package	57°C/W
N package	67°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T_{stg}	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltages are with respect to the network ground terminal.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

TL145406

TRIPLE RS-232 DRIVERS/RECEIVERS

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recommended operating conditions

		MIN	NOM	MAX	UNIT
V _{DD}	Supply voltage	7.5	9	15	V
V _{SS}	Supply voltage	-7.5	-9	-15	V
V _{CC}	Supply voltage	4.5	5	5.5	V
V _{IH}	High-level input voltage (driver only)	1.9			V
V _{IL}	Low-level input voltage (driver only)			0.8	V
I _{OH}	High-level output current	Driver		-6	mA
		Receiver		-0.5	
I _{OL}	Low-level output current	Driver		6	mA
		Receiver		16	
T _A	Operating free-air temperature	0		70	°C

supply currents

PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT
I _{DD}	All inputs at 1.9 V, No load	V _{DD} = 9 V, V _{SS} = -9 V			15	mA
		V _{DD} = 12 V, V _{SS} = -12 V			19	
		V _{DD} = 15 V, V _{SS} = -15 V			25	
	All inputs at 0.8 V, No load	V _{DD} = 9 V, V _{SS} = -9 V			4.5	
		V _{DD} = 12 V, V _{SS} = -12 V			5.5	
		V _{DD} = 15 V, V _{SS} = -15 V			9	
I _{SS}	All inputs at 1.9 V, No load	V _{DD} = 9 V, V _{SS} = -9 V			-15	mA
		V _{DD} = 12 V, V _{SS} = -12 V			-19	
		V _{DD} = 15 V, V _{SS} = -15 V			-25	
	All inputs at 0.8 V, No load	V _{DD} = 9 V, V _{SS} = -9 V			-3.2	
		V _{DD} = 12 V, V _{SS} = -12 V			-3.2	
		V _{DD} = 15 V, V _{SS} = -15 V			-3.2	
I _{CC}	All inputs at 5 V, No load, V _{CC} = 5 V		13.2	20	mA	

DRIVER SECTION

electrical characteristics over recommended operating free-air temperature range, $V_{DD} = 9\text{ V}$, $V_{SS} = -9\text{ V}$, $V_{CC} = 5\text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
V_{OH}	High-level output voltage	$V_{IL} = 0.8\text{ V}$,	$R_L = 3\text{ k}\Omega$,	See Figure 1	6	7.5		V
V_{OL}	Low-level output voltage (see Note 3)	$V_{IH} = 1.9\text{ V}$,	$R_L = 3\text{ k}\Omega$,	See Figure 1		-7.5	-6	V
I_{IH}	High-level input current	$V_I = 5\text{ V}$,	See Figure 2				10	μA
I_{IL}	Low-level input current	$V_I = 0$,	See Figure 2				-1.6	mA
$I_{OS(H)}$	High-level short-circuit output current (see Note 4)	$V_{IL} = 0.8\text{ V}$,	$V_O = 0\text{ or }V_{SS}$,	See Figure 1	-4.5	-10	-19.5	mA
$I_{OS(L)}$	Low-level short-circuit output current	$V_{IH} = 2\text{ V}$,	$V_O = 0\text{ or }V_{DD}$,	See Figure 1	4.5	10	19.5	mA
r_O	Output resistance (see Note 5)	$V_{CC} = V_{DD} = V_{SS} = 0$, $V_O = -2\text{ V to }2\text{ V}$			300			Ω

- NOTES: 3. The algebraic convention, where the more positive (less negative) limit is designated as maximum, is used in this data sheet for logic levels only (e.g., if -10 V is maximum, the typical value is a more negative voltage).
 4. Output short-circuit conditions must maintain the total power dissipation below absolute maximum ratings.
 5. Test conditions are those specified by TIA/EIA-232-F and as listed above.

switching characteristics, $V_{CC} = 5\text{ V}$, $V_{DD} = 12\text{ V}$, $V_{SS} = -12\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low- to high-level output	$R_L = 3\text{ k}\Omega\text{ to }7\text{ k}\Omega$, $C_L = 15\text{ pF}$, See Figure 3				315	500	ns
t_{PHL}	Propagation delay time, high- to low-level output	$R_L = 3\text{ k}\Omega\text{ to }7\text{ k}\Omega$, $C_L = 15\text{ pF}$, See Figure 3				75	175	ns
t_{TLH}	Transition time, low- to high-level output	$R_L = 3\text{ k}\Omega\text{ to }7\text{ k}\Omega$, $C_L = 15\text{ pF}$, See Figure 3				60	100	ns
		$R_L = 3\text{ k}\Omega\text{ to }7\text{ k}\Omega$, $C_L = 2500\text{ pF}$, See Figure 3 and Note 6				1.7	2.5	μs
t_{THL}	Transition time, high- to low-level output	$R_L = 3\text{ k}\Omega\text{ to }7\text{ k}\Omega$, $C_L = 15\text{ pF}$, See Figure 3				40	75	ns
		$R_L = 3\text{ k}\Omega\text{ to }7\text{ k}\Omega$, $C_L = 2500\text{ pF}$, See Figure 3 and Note 7				1.5	2.5	μs

- NOTES: 6. Measured between -3-V and 3-V points of the output waveform (TIA/EIA-232-F conditions). All unused inputs are tied.
 7. Measured between 3-V and -3-V points of the output waveform (TIA/EIA-232-F conditions). All unused inputs are tied.

TL145406 TRIPLE RS-232 DRIVERS/RECEIVERS

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RECEIVER SECTION

electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT
V_{IT+}	Positive-going threshold voltage	See Figure 5	$T_A = 25^\circ\text{C}$	1.75	1.9	2.3	V
			$T_A = 0^\circ\text{C to } 70^\circ\text{C}$	1.55		2.3	
V_{IT-}	Negative-going threshold voltage			0.75	0.97	1.25	V
V_{hys}	Input hysteresis ($V_{IT+} - V_{IT-}$)			0.5			V
V_{OH}	High-level output voltage	$I_{OH} = -0.5\text{ mA}$	$V_{IH} = 0.75\text{ V}$	2.6	4	5	V
			Inputs open	2.6			
V_{OL}	Low-level output voltage	$I_{OL} = 10\text{ mA}$,	$V_I = 3\text{ V}$		0.2	0.45	V
I_{IH}	High-level input current	$V_I = 25\text{ V}$,	See Figure 5	3.6		8.3	mA
		$V_I = 3\text{ V}$,	See Figure 5	0.43			
I_{IL}	Low-level input current	$V_I = -25\text{ V}$,	See Figure 5	-3.6		-8.3	mA
		$V_I = -3\text{ V}$,	See Figure 5	-0.43			
I_{OS}	Short-circuit output current				-3.4	-12	mA

† All typical values are at $T_A = 25^\circ\text{C}$, $V_{CC} = 5\text{ V}$, $V_{DD} = 9\text{ V}$, and $V_{SS} = -9\text{ V}$.

switching characteristics, $V_{CC} = 5\text{ V}$, $V_{DD} = 12\text{ V}$, $V_{SS} = -12\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low- to high-level output	$C_L = 50\text{ pF}$,	$R_L = 5\text{ k}\Omega$,	See Figure 6		107	425	ns
t_{PHL}	Propagation delay time, high- to low-level output	$C_L = 50\text{ pF}$,	$R_L = 5\text{ k}\Omega$,	See Figure 6		42	150	ns
t_{TLH}	Transition time, low- to high-level output	$C_L = 50\text{ pF}$,	$R_L = 5\text{ k}\Omega$,	See Figure 6		175	400	ns
t_{THL}	Transition time, high- to low-level output	$C_L = 50\text{ pF}$,	$R_L = 5\text{ k}\Omega$,	See Figure 6		16	60	ns

PARAMETER MEASUREMENT INFORMATION

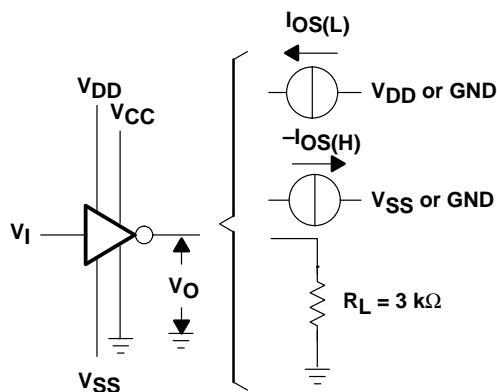


Figure 1. Driver Test Circuit for V_{OH} , V_{OL} , $I_{OS(H)}$, and $I_{OS(L)}$

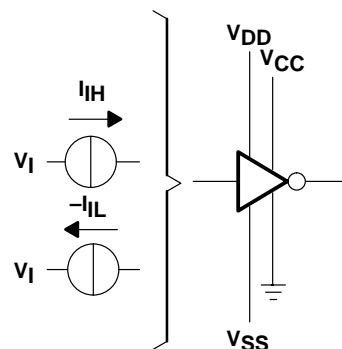
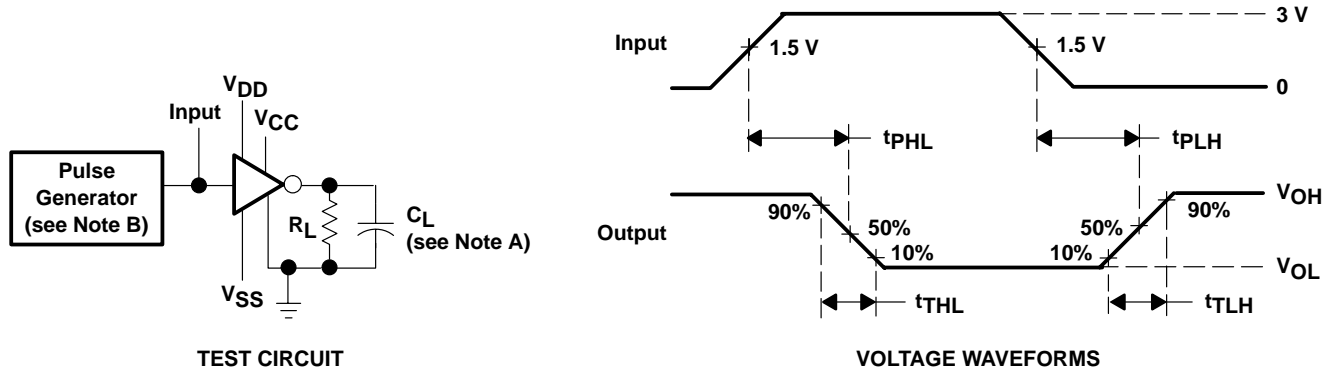


Figure 2. Driver Test Circuit for I_{IH} and I_{IL}

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.
B. The pulse generator has the following characteristics: $t_w = 25 \mu s$, $PRR = 20 \text{ kHz}$, $Z_O = 50 \Omega$, $t_r = t_f < 50 \text{ ns}$.

Figure 3. Driver Test Circuit and Voltage Waveforms

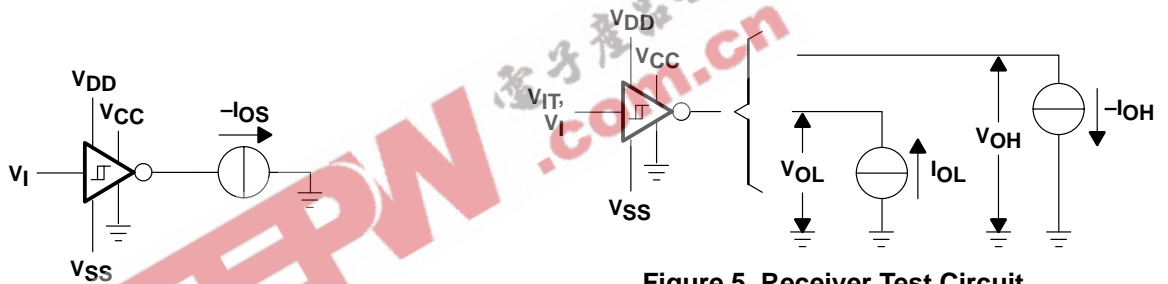
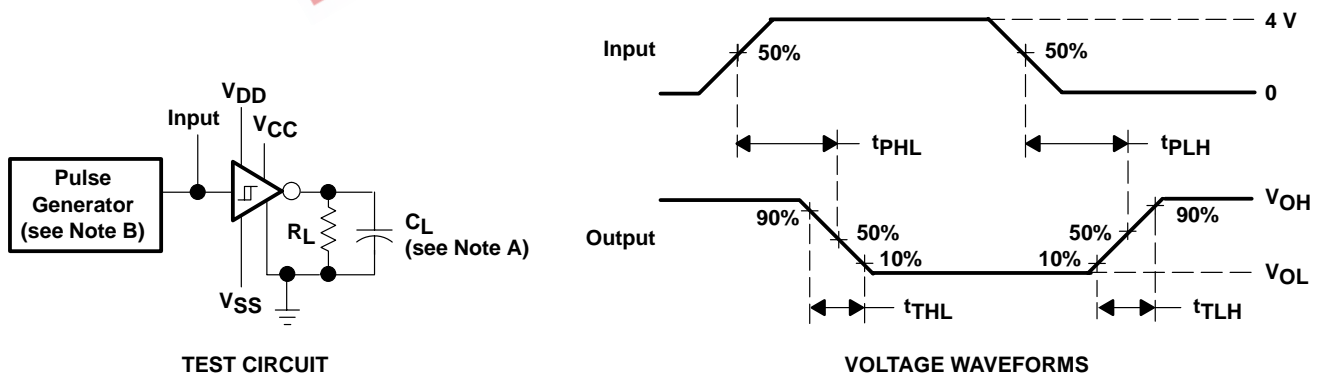


Figure 4. Receiver Test Circuit for I_{OS}

Figure 5. Receiver Test Circuit for V_{IT} , V_{OH} , and V_{OL}



NOTES: A. C_L includes probe and jig capacitance.
B. The pulse generator has the following characteristics: $t_w = 25 \mu s$, $PRR = 20 \text{ kHz}$, $Z_O = 50 \Omega$, $t_r = t_f < 50 \text{ ns}$.

Figure 6. Receiver Propagation and Transition Times

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TYPICAL CHARACTERISTICS

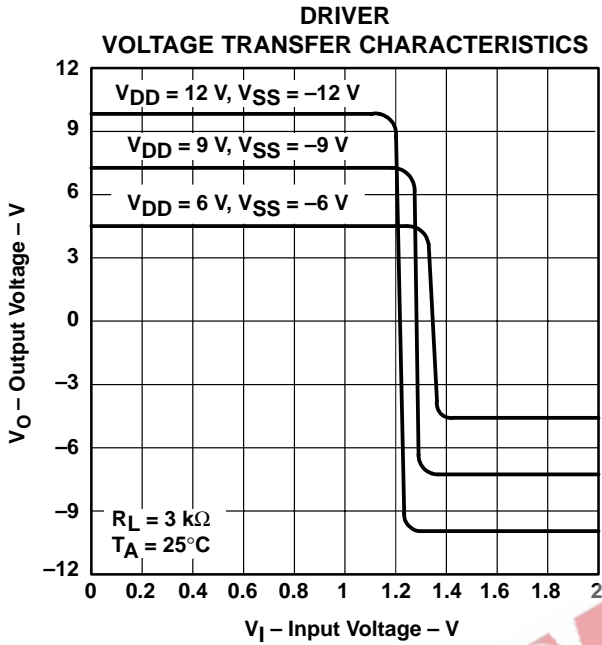


Figure 7

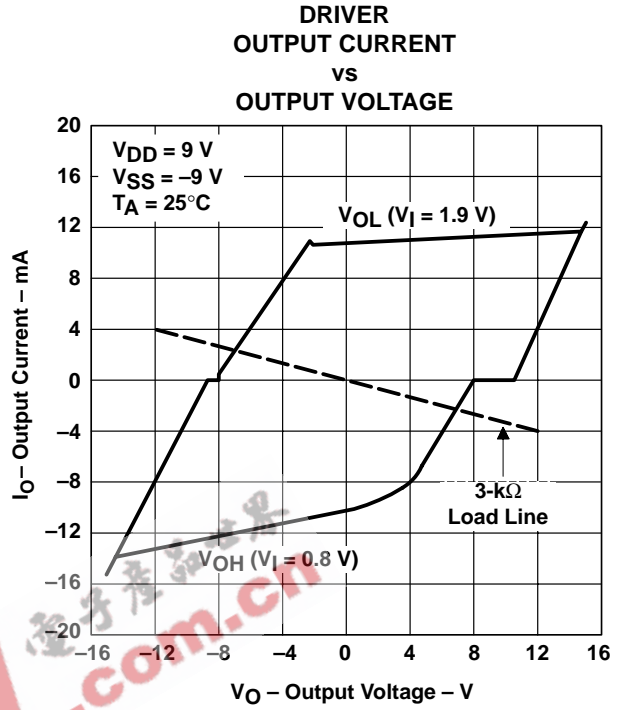


Figure 8

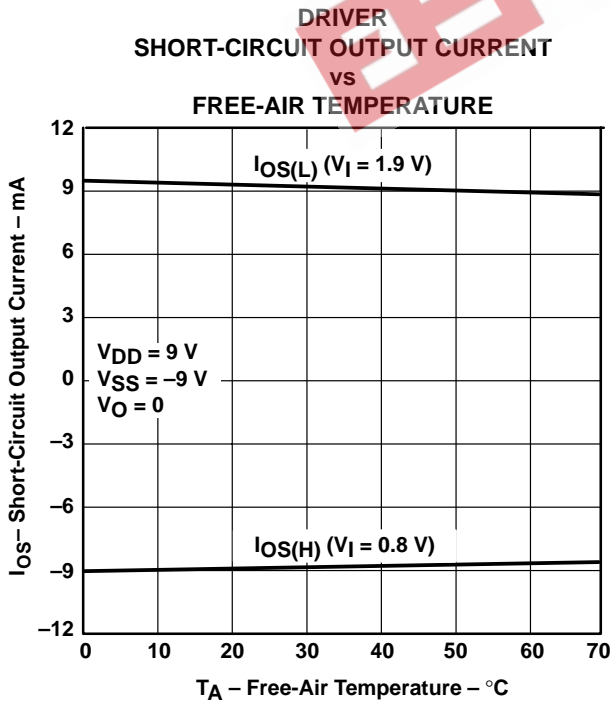


Figure 9

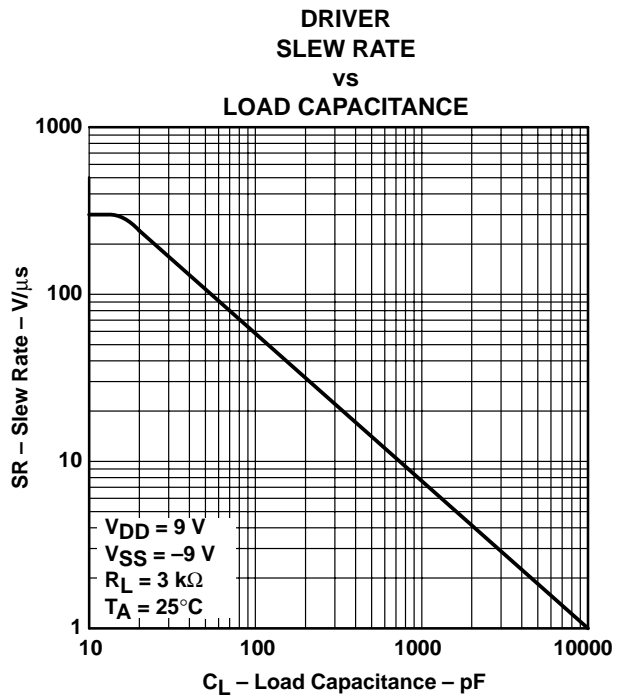


Figure 10

TYPICAL CHARACTERISTICS

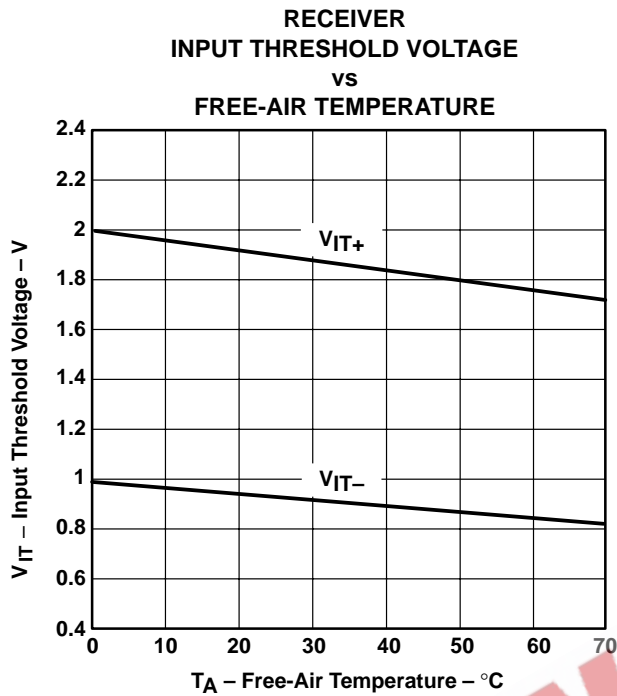


Figure 11

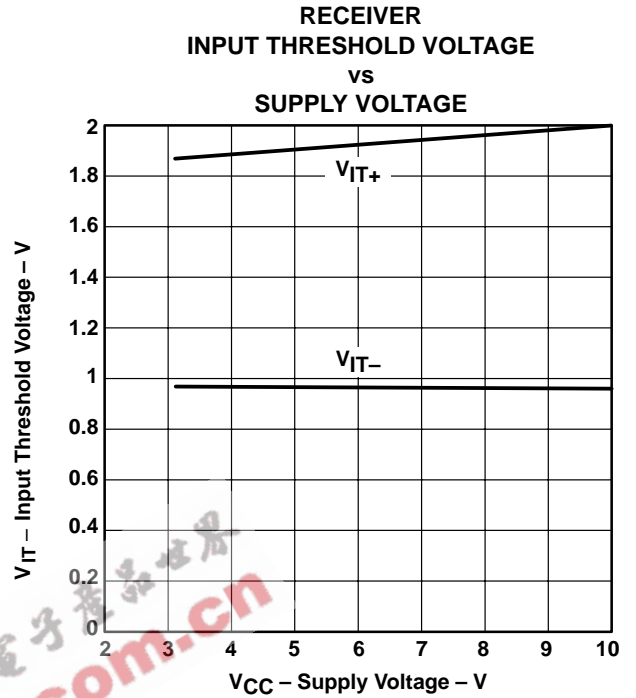
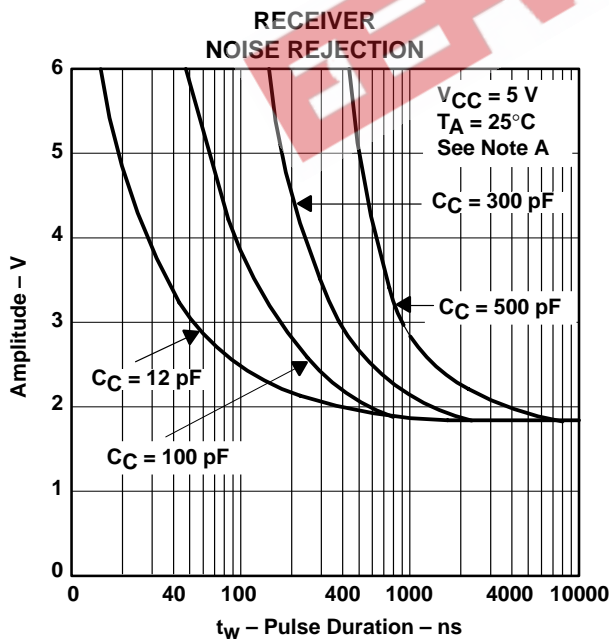


Figure 12



NOTE A: This figure shows the maximum amplitude of a positive-going pulse that, starting from 0, does not cause a change of the output level.

Figure 13

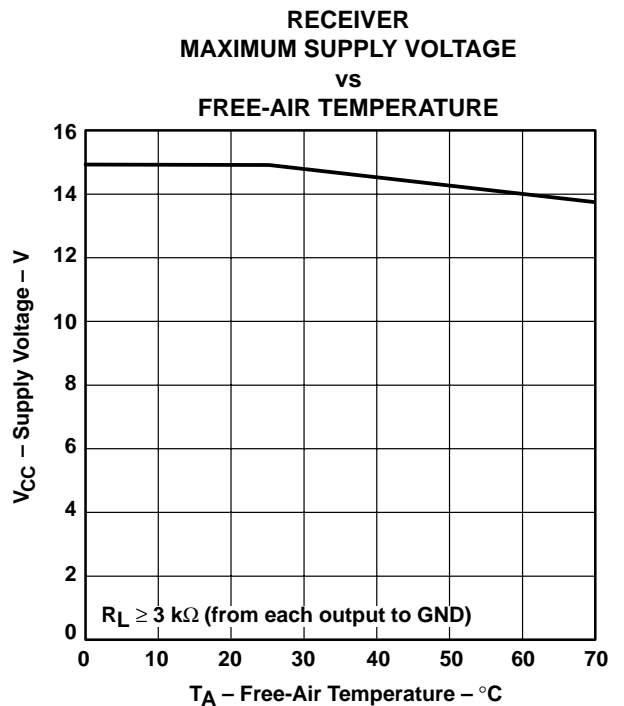


Figure 14

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APPLICATION INFORMATION

Diodes placed in series with the V_{DD} and V_{SS} leads protect the TL145406 during the fault condition in which the device outputs are shorted to ± 15 V and the power supplies are at low. Diodes also provide low-impedance paths to ground (see Figure 15).

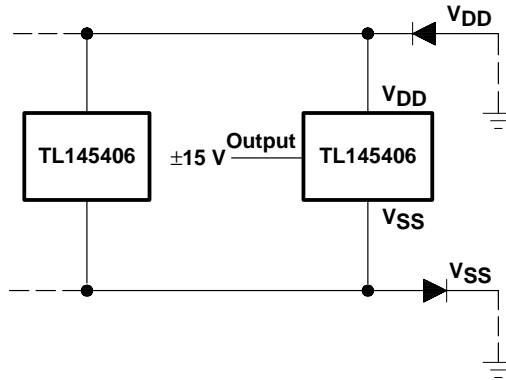


Figure 15. Power-Supply Protection to Meet Power-Off Fault Conditions of ANSI TIA/EIA-232-F

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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TL145406DW	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL145406DWE4	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL145406DWR	ACTIVE	SOIC	DW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL145406DWRE4	ACTIVE	SOIC	DW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL145406N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TL145406NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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MECHANICAL DATA

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

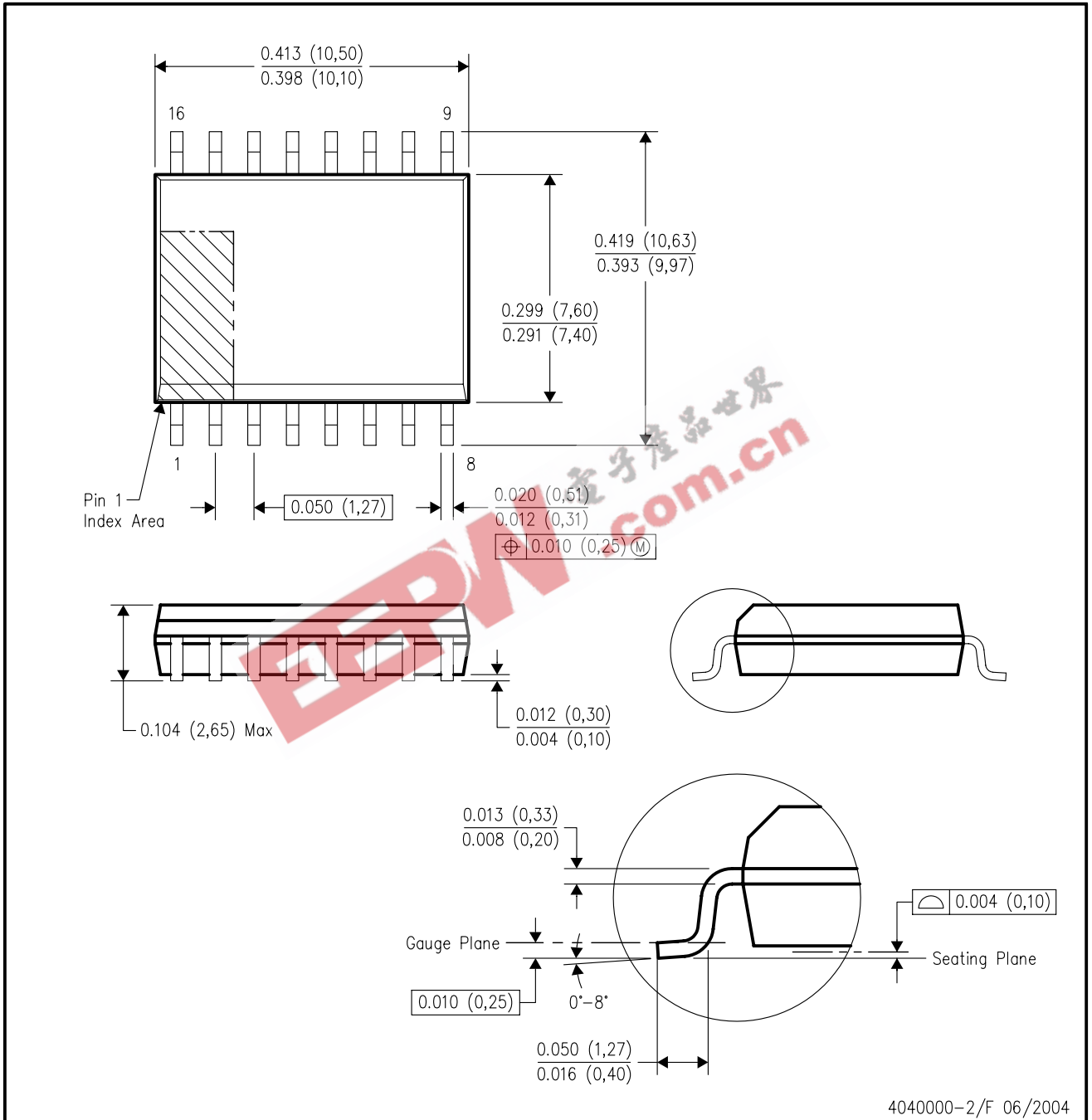


- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

MECHANICAL DATA

DW (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - D. Falls within JEDEC MS-013 variation AA.

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